



#### LOW CAPACITANCE BIDIRECTIONAL TVS DIODE

#### **Features**

- Provides ESD Protection per IEC 61000-4-2 Standard: Air – ±30kV, Contact – ±30kV
- 1 Channel of ESD Protection
- Low Channel Input Capacitance
- Typically Used at Computer Interface Protection, Data Line and Power Line Protection
- PPAP Capable
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

### **Mechanical Data**

- Case: SOD323
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Weight: 0.004 grams (approximate)



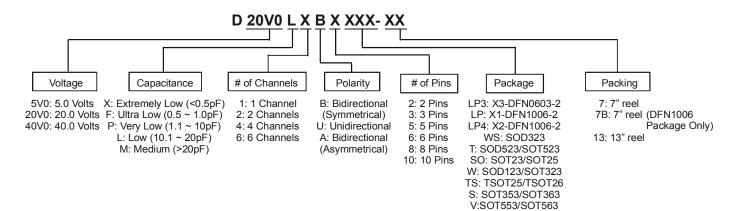


Top View



**Device Schematic** 

#### **Ordering Information** (Note 4)

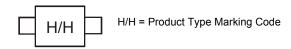


Product	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
D20V0L1B2WS-7	AEC-Q101	H/H	7	8	3,000/Tape & Reel
D20V0L1B2WSQ-7	Automotive	H/H	7	8	3,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

# **Marking Information**





# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	$P_PP$	90	W	8/20µs, Per Figure 2
Peak Pulse Current	I <sub>PP</sub>	3	Α	8/20µs, Per Figure 2
ESD Protection – Contact Discharge	V <sub>ESD_Contact</sub>	±30	kV	Standard IEC 61000-4-2
ESD Protection – Air Discharge	$V_{ESD\_Air}$	±30	kV	Standard IEC 61000-4-2

## **Thermal Characteristics**

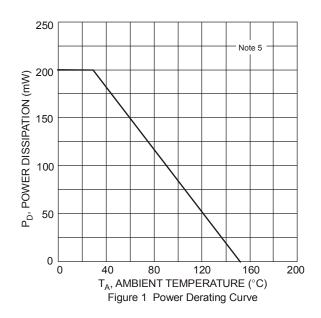
Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	P <sub>D</sub>	200	mW
Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	625	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

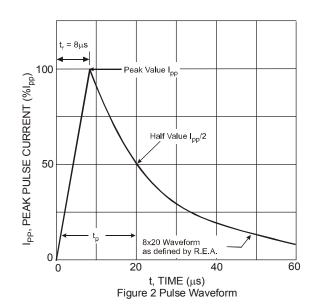
## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Standoff Voltage	$V_{RWM}$	_	_	20	V	_
Channel Leakage Current (Note 6)	I <sub>RM</sub>	1	1	100	nA	V <sub>RWM</sub> = 20V
Clamping Valtage Desitive Transients	V <sub>CL</sub>	_	_	27	V	$I_{PP} = 1A$ , $t_p = 8/20 \mu S$
Clamping Voltage, Positive Transients		_	_	30	V	$I_{PP} = 3A$ , $t_p = 8/20 \mu S$
Breakdown Voltage	$V_{BR}$	21	_	25	V	I <sub>R</sub> = 1mA
Differential Resistance	R <sub>DIF</sub>	_	1.8	_	Ω	$I_R = 1A$ , $t_p = 8/20 \mu S$
Channel Input Capacitance	C <sub>T</sub>	1	10	15	pF	$V_R = 0V$ , $f = 1MHz$

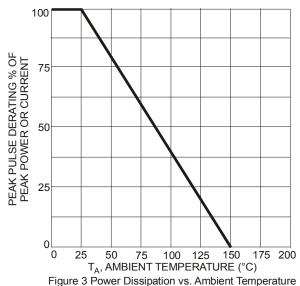
Notes:

- 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com.
- 6. Short duration pulse test used to minimize self-heating effect.









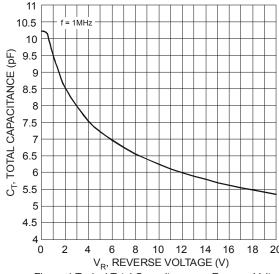
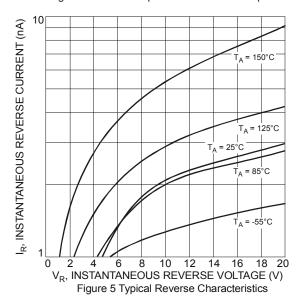
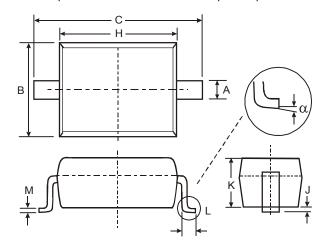


Figure 4 Typical Total Capacitance vs. Reverse Voltage



# **Package Outline Dimensions**

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.

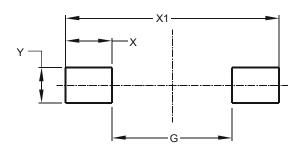


SOD323				
Dim	Min	Max		
Α	0.25	0.35		
В	1.20	1.40		
С	2.30	2.70		
Н	1.60	1.80		
J	0.00	0.10		
K	1.0	1.1		
L	0.20	0.40		
M	0.10	0.15		
α	0°	8°		
All Dimensions in mm				



### **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
G	1.520
Х	0.590
X1	2.700
Υ	0.450

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